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Nanomanufacturing - Key control characteristics - Part 11-1: Electromagnetic compatibility - Shielding effectiveness of nanomaterials: near-field probe method

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

Nanomanufacturing Key control characteristics Part 11-1: Electromagnetic compatibility Shielding effectiveness of nanomaterials: near-field probe method

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IEC TS 62607-11-1 has been prepared by IEC technical committee 113: Nanotechnology for electrotechnical products and systems. It is a Technical Specification.

The text of this Technical Specification is based on the following documents:

Draft	Report on voting
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Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this Technical Specification is English.